

#### **MAX16731**

## **General Description**

The MAX16731 is a fully integrated, highly efficient, step-down DC-DC switching regulator. The regulator is able to operate from 2.7V to 16V input supplies, and the output can be adjusted from 0.5V to 5.8V, delivering up to 30A of load current.

The switching frequency of the device can be configured from 500kHz to 1.5MHz and can optimize the design in terms of size and performance.

The MAX16731 utilizes fixed frequency, current-mode control with internal compensation. The IC features advanced modulation scheme (AMS) and selectable discontinuous current mode (DCM) operation to provide improved performance. Operation settings and configurable features can be selected by three programming pins PGM0, PGM1, and PGM2.

The MAX16731 has an internal 1.8V linear regulator (LDO) output to power the gate drives (VCC) and internal circuitry (AVDD).

The IC has multiple protections, including positive and negative overcurrent protection, output overvoltage protection, and overtemperature protection to ensure robust design.

The device is available in a compact 2.52mm x 4.89mm WLP package. It supports -40°C to +125°C junction temperature operation.

## **Applications**

- Communications Equipment
- Networking Equipment
- Servers and Storage Equipment
- Point-of-Load Voltage Regulators
- Memory V<sub>DDQ</sub>

Ordering Information appears at end of data sheet.

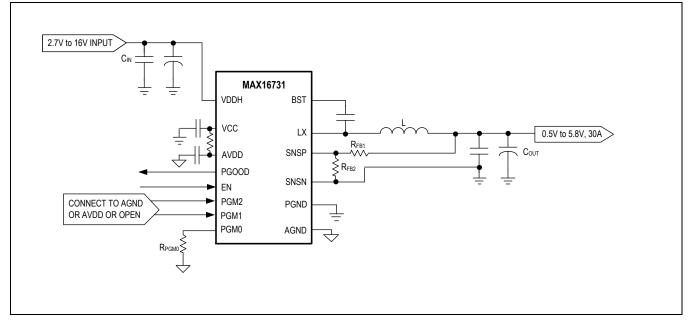
### **Benefits and Features**

- High Power Density with Low Component Count
   Compact 2.52mm x 4.89mm, 45-Bump, WLP
  - Package
  - Internal Compensation
  - Single Supply Operation with Integrated LDO for Bias Generation
- Wide Operating Range
  - 2.7V to 16V Input Voltage Range
  - 0.5V to 5.8V Output Voltage Range
  - 500kHz to 1.5MHz Configurable Switching Frequency
  - -40°C to +125°C Junction Temperature Range
  - Three Programming Pins to Select Different Configurations
- Optimized Performance and Efficiency
  - 91.2% Peak Efficiency with  $V_{DDH}$  = 12V,  $V_{OUT}$  = 1.2V, and  $f_{SW}$  = 500kHz
  - · AMS to Improve Load Transient
  - Selectable DCM to Improve Light Load Efficiency
  - · Differential Remote Sense

DESCRIPTION	CURRENT RATING* (A)	INPUT VOLTAGE (V)	OUTPUT VOLTAGE (V)
Electrical Rating	30	2.7 to 16	0.5 to 5.8
Thermal Rating $T_A = 55^{\circ}C$ , 200LFM air flow	29	12	1.8
Thermal Rating T <sub>A</sub> = 85°C, no air flow	21	12	0.8

\*Maximum  $T_J = 125$ °C. For specific operating conditions, see the Safe Operating Area (SOA) curves in the <u>Typical</u> <u>Operating Characteristics</u> section.

# **Simplified Application Circuit**



## **Absolute Maximum Ratings**

VDDH to PGND (Note 1)	0.3V to +19V
LX to PGND (DC)	0.3V to +19V
LX to PGND (AC) (Note 2)	10V to +23V
VDDH to LX (DC) (Note 1)	0.3V to +19V
VDDH to LX (AC) (Note 2)	10V to +23V
BST to PGND (DC)	0.3V to +21.5V
BST to PGND (AC) (Note 2)	7V to +25.5V
BST to LX	0.3V to +2.5V
PGND to AGND	0.3V to +0.3V

Vcc to PGND	0.3V to +2.5V
AVDD to AGND	0.3V to +2.5V
EN, PGOOD to AGND	0.3V to +4V
SNSP to AGND	0.3V to AVDD+0.3V
SNSN to AGND	0.3V to +0.3V
PGM0, PGM1, PGM2 to AGND	0.3V to AVDD+0.3V
Peak LX Current	54A to +56A
Junction Temperature $(T_J)$ (Note 3)	+150°C
Storage Temperature Range	65°C to +150°C
Peak Reflow Temperature Lead-Free	+260°C

**Note 1:** Input HF capacitors placed not more than 40 mils away from the V<sub>DDH</sub> pin to keep inductive voltage spikes within Absolute Maximum limits.

Note 2: AC is limited to 25ns.

**Note 3:** Recommended operating junction temperature from -40°C to +125°C. The device guarantees 90k hours of continuous operation with 30A output current at +85°C junction temperature, or 40k hours of continuous operation with 24A output current at +105°C junction temperature, for a typical application with 12V input, 1.2V output.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **Package Information**

Package Code	W452A4Z+1
Outline Number	<u>21-100425</u>
Land Pattern Number	Refer to Application Note 1891
Thermal Resistance	
Junction-to-Ambient Thermal Resistance (θ <sub>JA</sub> ) JEDEC	35.73°C/W
Junction-to-Ambient Thermal Resistance (θ <sub>JA</sub> ) on	14.5°C/W
MAX16731EVKIT# (no heat sink, no airflow)	

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a fourlayer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

## **Electrical Characteristics**

(See Typical Application Circuit.  $V_{DDH} = 12V$ ,  $T_A = T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Specifications are production tested at  $T_A = +32^{\circ}C$ ; limits within the operating temperature range are guaranteed by design and characterization.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Input Supply						
Input Voltage Range	V <sub>DDH</sub>		2.7		16	V
Input Supply Current	I <sub>VDDH</sub>	EN = AGND		0.25		mA
Internal LDO Regulated Output	V <sub>CC</sub>		1.71		1.95	V
AVDD Undervoltage Lockout	AVDD	Rising	1.65	1.67	1.70	V
AVDD Undervoltage Lockout Hysteresis				55		mV
VDDH Undervoltage Lockout		Rising	2.4	2.5	2.6	V
VDDH Undervoltage Lockout Hysteresis				100		mV
VDDH Overvoltage Lockout		Rising	17.3	17.8	18.3	V
VDDH Overvoltage Lockout Hysteresis				500		mV
Output Voltage Range a	nd Accuracy					
Internal Reference			0.495	0.500	0.505	v
Voltage		$T_A = T_J = 0^{\circ}C$ to +85°C	0.497	0.500	0.503	
Positive Voltage Sense Leakage Current	I <sub>SNSP</sub>	$T_{A} = T_{J} = +25^{\circ}C$	-1		1	μA
Negative Voltage Sense Input Range	V <sub>SNSN</sub>		-100		+100	mV
Negative Voltage Sense Leakage Current	I <sub>SNSN</sub>				550	μA
Switching Frequency						
				500		
				600		
	_			750		1
Switching Frequency	F <sub>SW</sub>			1000		kHz
				1200		
				1500		-
Switching Frequency Accuracy			-10		+10	%
Minimum Controllable		Inductor Valley Current ≤ 0A (Note 4)		35.0	51.3	
On-Time		Inductor Valley Current > 0A (Note 4)		32.8	45.3	ns
Minimum Controllable Off-Time				100		ns
Enable and Startup						
Initialization Time	t <sub>INIT</sub>			540		μs
		Rising	0.9			N
EN Threshold		Falling	0.6			V
EN Filtering Delay	<sup>t</sup> EN_RISING_DE LAY	Rising		200		μs

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
	ten_falling_d Elay	Falling		2		
Soft-Start Time	t <sub>SS</sub>			3		ms
Power Good and Fault F	Protections					
PGOOD Output Low		I <sub>PGOOD</sub> = 4mA			0.4	V
Output Undervoltage		Falling	-16	-13	-10	%
(UV) Threshold		Rising		-10		/0
Output UV Deglitch Delay				4		μs
Output Overvoltage Protection (OVP) Threshold			10	13	16	%
Output OVP Deglitch Delay				2		μs
Positive Overcurrent		Inductor Peak Current, POCP = 38A	34.6	38.0	41.4	
Protection (POCP)		Inductor Peak Current, POCP = 33A	29.9	33.0	36.1	А
Threshold		Inductor Peak Current, POCP = 28A	25.1	28.0	30.9	
POCP Deglitch Delay	t <sub>POCP</sub>			51		ns
Fast Positive Overcurrent Protection (FPOCP) Threshold			44	48	52	A
Negative Overcurrent Protection (NOCP) Threshold to POCP Threshold Ratio				-84		%
NOCP Accuracy			-20		+20	%
BST UVLO Threshold	V <sub>BST</sub>	Rising	1.48	1.56	1.64	V
BST UVLO Threshold Hysteresis				52		mV
Overtemperature Protection (OTP) Rising Threshold				155		°C
OTP Accuracy				6		%
OTP Hysteresis				20		°C
Hiccup Protection Time				20		ms
DCM Operation Mode						
		POCP = 38A, Inductor Valley Current		-1.73		
DCM Comparator Threshold to Enter DCM		POCP = 33A, Inductor Valley Current		-1.57		A
		POCP = 28A, Inductor Valley Current		-1.26		1
DCM Comparator Threshold to Exit DCM		Inductor Valley Current		0.6		А
Programming Pins						
PGM0 Pin Resistor Range			0.095		115	kΩ
PGM0 Resistor Accuracy			-1		+1	%

(See Typical Application Circuit.  $V_{DDH} = 12V$ ,  $T_A = T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Specifications are production tested at  $T_A = +32^{\circ}C$ ; limits within the operating temperature range are guaranteed by design and characterization.)

# 30A, 1.5MHz, 2.7V to 16V Integrated Step-Down Switching Regulator

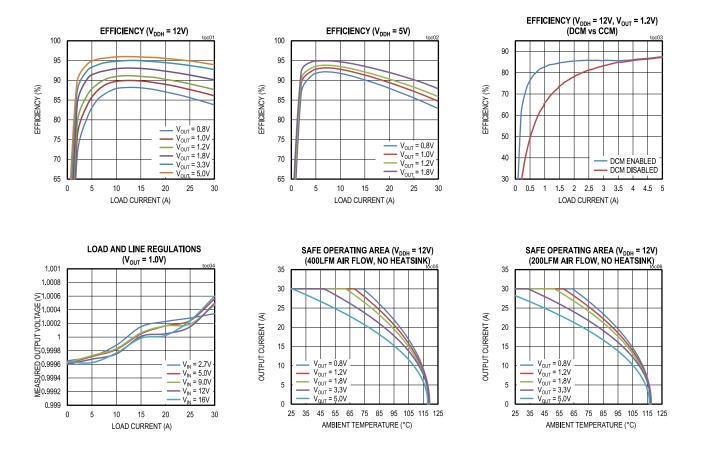
(See Typical Application Circuit.  $V_{DDH} = 12V$ ,  $T_A = T_J = -40^{\circ}$ C to  $+125^{\circ}$ C, unless otherwise noted. Specifications are production tested at  $T_A = +32^{\circ}$ C; limits within the operating temperature range are guaranteed by design and characterization.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
PGM1 / PGM2 3-Level Detection Thresholds		PGM_ Pin Connected to AVDD	AVDD – 0.2			
		PGM_ Pin OPEN		0.68		V
		PGM_ Pin Connected to AGND or PGM0			0.24 × AVDD	
PGM1 / PGM2 Input		PGM_ Pin Connected to AVDD		250		
Current		PGM_ Pin Connected to AGND or PGM0		-315		μA

Note 4: Guaranteed by design.

## **Typical Operating Characteristics**

(Typical Application Circuit, tested on MAX16731EVKIT#,  $V_{DDH}$  = 12V,  $F_{SW}$  = 500kHz,  $T_A$  = +25°C, Inductor = FP1008R5-R220-R or 744309047 for  $V_{OUT}$  > 2.5V, unless otherwise noted.)



## 30A, 1.5MHz, 2.7V to 16V Integrated Step-Down Switching Regulator

SAFE OPERATING AREA (V<sub>DDH</sub> = 12V) (NO AIR FLOW, NO HEATSINK) SAFE OPERATING AREA (V<sub>DDH</sub> = 5V) (400LFM AIR FLOW, NO HEATSINK) SAFE OPERATING AREA (V<sub>DDH</sub> = 5V) (200LFM AIR FLOW, NO HEATSINK) 35 35 35 30 30 30 25 25 25 OUTPUT CURRENT (A) OUTPUT CURRENT (A) OUTPUT CURRENT (A) 20 20 20 15 15 15 V<sub>OUT</sub> = 0.8V 10 10 10  $V_{OUT} = 1.2V$   $V_{OUT} = 1.8V$   $V_{OUT} = 3.3V$ V<sub>OUT</sub> = 0.8V V<sub>OUT</sub> = 1.2V V<sub>OUT</sub> = 0.8V 5 5 5 V<sub>OUT</sub> = 1.2V V<sub>OUT</sub> = 1.8V /<sub>QUT</sub> = 5.0V V<sub>QUT</sub> = 1.8V 0 0 0 25 35 45 55 65 75 85 95 105 115 125 25 35 45 55 65 75 85 95 105 115 125 25 35 45 55 65 75 85 95 105 115 125 AMBIENT TEMPERATURE (°C) AMBIENT TEMPERATURE (°C) AMBIENT TEMPERATURE (°C) SAFE OPERATING AREA (V<sub>DDH</sub> = 5V) (NO AIR FLOW, NO HEATSINK) STARTUP PRE-BIASED STARTUP (I<sub>OUT</sub> = 25A) (V<sub>PREBIAS</sub> = 0.5V) toc12 35 200mV/div 200mV/div 30 2V/div 2V/div 25 ΕN ΕN OUTPUT CURRENT (A) 20 V<sub>OUT</sub> 2V/div 2V/div 15 PGOOD PGOOD 10 Vout V<sub>OUT</sub> = 0.8V 5 V<sub>OUT</sub> = 1 2V V<sub>OUT</sub> = 1 8V 10V/div 10V/div LX LX 0 25 35 45 55 65 75 85 95 105 115 125 500µs/div 500µs/div AMBIENT TEMPERATURE (°C) OUTPUT VOLTGE RIPPLE SHUTDOWN OUTPUT VOLTGE RIPPLE (DCM OPERATION) (I<sub>OUT</sub> = 5A) (V<sub>OUT</sub> = 1.0V, I<sub>OUT</sub> = 25A) (V<sub>OUT</sub> = 1.0V, I<sub>OUT</sub> = 100mA) toc13 Vou 500mV/div Vout 50mV/div ΕN Vout 20mV/div 2V/div PGOOD 2V/div 5V/div LX LX 5V/div 10V/div LX

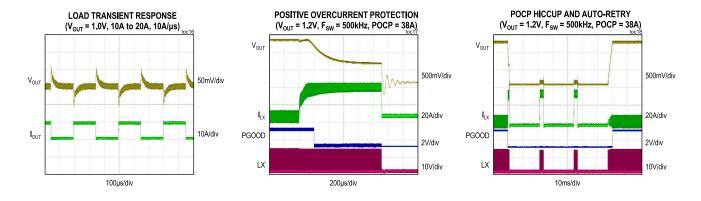
2µs/div

(Typical Application Circuit, tested on MAX16731EVKIT#,  $V_{DDH}$  = 12V,  $F_{SW}$  = 500kHz,  $T_A$  = +25°C, Inductor = FP1008R5-R220-R or 744309047 for  $V_{OUT}$  > 2.5V, unless otherwise noted.)

5µs/div

20µs/div

(Typical Application Circuit, tested on MAX16731EVKIT#,  $V_{DDH}$  = 12V,  $F_{SW}$  = 500kHz,  $T_A$  = +25°C, Inductor = FP1008R5-R220-R or 744309047 for  $V_{OUT}$  > 2.5V, unless otherwise noted.)



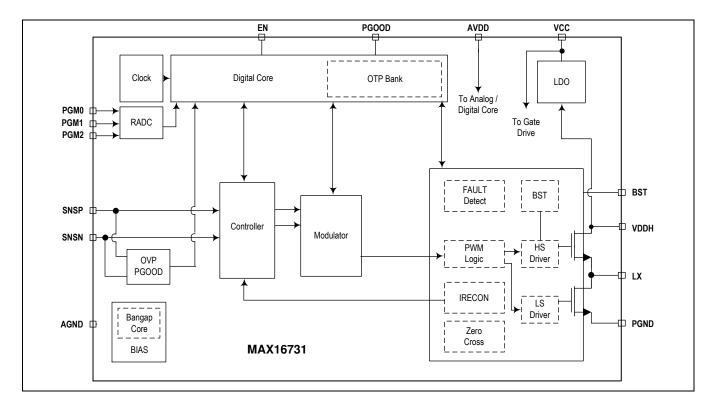
## **Pin Configurations**

	А	В	С	D	E
	PGND	PGND	PGND	PGND	PGND
9	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
	LX	LX	LX	LX	LX
8	()	()	()	()	()
	PGND	PGND	PGND	PGND	PGND
7	$\bigcirc$	(	()	$\bigcirc$	$\bigcirc$
	LX	LX	LX	LX	LX
6	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
	PGND	PGND	PGND	PGND	PGND
5	$\bigcirc$	$\left( \begin{array}{c} \\ \\ \end{array} \right)$	(	$(\mathbf{x})$	$\bigcirc$
	LX	LX	LX	LX	LX
4	()	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
	BST	VDDH	VDDH	VDDH	VDDH
3	VCC	PGM1	PGM2	() SNSN	EN
	VCC		FGIVIZ	SINOIN	
2	() PGM0	() AVDD	() AGND	() SNSP	() PGOOD
	FGIVIU	AVDD	AGND	SNOP	FGOOD
1	()	()	()	()	$\bigcirc$
			(TOP VIEW)		

# **Pin Descriptions**

PIN	NAME	FUNCTION
A1	PGM0	Program Input. Connect this pin to ground though a programming resistor.
B1	AVDD	1.8V Supply for Analog Circuitry. Connect a 2.2 $\Omega$ to 4.7 $\Omega$ resistor from AVDD to V <sub>CC</sub> . Connect a 1 $\mu$ F or greater ceramic capacitor from AVDD to AGND.
C1	AGND	Analog Ground.
D1	SNSP	Output Voltage Remote Sense Positive Input Pin. Connect SNSP to output voltage at the load. A resistive voltage divider can be inserted between the output and SNSP to regulate the output above the reference voltage.
E1	PGOOD	Open-Drain Power Good Output.
A2	V <sub>CC</sub>	Internal 1.8V LDO Output. Connect a 4.7 $\mu$ F or greater ceramic capacitor from V <sub>CC</sub> to PGND.
B2	PGM1	Program Input. Connect this pin to AGND or AVDD or leave it unconnected.
C2	PGM2	Program Input. Connect this pin to AGND or AVDD or leave it unconnected.
D2	SNSN	Output Voltage Remote Sense Negative Input.
E2	EN	Output Enable.
A3	BST	Bootstrap Pin. Connect a 0.47µF ceramic capacitor from BST to LX.
B3, C3, D3, E3	V <sub>DDH</sub>	Regulator Input Supply.
A4-E4, A6- E6, A8-E8	LX	Switching Node. Connect LX directly to the output inductor.
A5-E5, A7- E7, A9-E9	PGND	Power Ground.

## **Block Diagram**



### **Detailed Description**

#### **Control Architecture**

#### Fixed-Frequency, Peak-Current-Mode Control Loop

The MAX16731 control loop is based on the fixed-frequency, peak-current-mode control architecture. A simplified control architecture is shown in <u>Figure 1</u>. The loop contains an error amplifier stage, internal voltage loop compensation network, current sense, internal slope compensation, and a PWM modulator that generates the PWM signals to drive high-side and low-side MOSFETs. The device has a fixed 0.5V reference voltage ( $V_{REF}$ ). The difference of  $V_{REF}$  and the sensed output voltage is amplified by the first error amplifier. Its output voltage ( $V_{ERR}$ ) is used as the input of the voltage loop compensation network. The output of the compensation network ( $V_{COMP}$ ) is fed to a PWM comparator with the current-sense signal ( $V_{ISENSE}$ ) and the slope compensation ( $V_{RAMP}$ ). The output of the PWM comparator is the input of the PWM modulator. The turning on of the high-side MOSFET is aligned with an internal clock. It is a fixed-frequency phase-shifted clock generated by the AMS block (see the <u>Advanced Modulation Scheme (AMS)</u>).

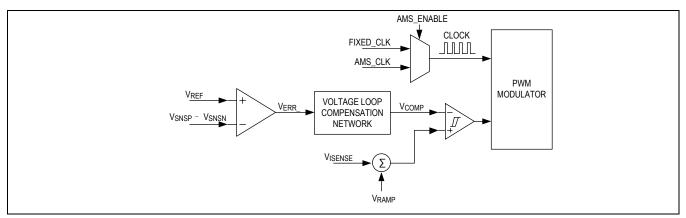


Figure 1. Simplified Control Architecture

#### Advanced Modulation Scheme (AMS)

The device offers the AMS to provide improved transient response. The AMS provides a significant advantage over conventional fixed-frequency PWM schemes. The AMS feature allows for modulation at both the leading and trailing edges, which result in a temporary increase or decrease of the switching frequency during large load transients. *Figure 2* shows the scheme to include the leading-edge modulation to the traditional trailing-edge modulation when AMS is enabled in the device. The modulation scheme allows the turn on and off with minimal delay. Since the total inductor current increases very quickly, satisfying the load demand, the current drawn from the output capacitors is reduced. With AMS enabled, the system closed-loop bandwidth can be extended without phase-margin penalty. As a result, the output capacitance can be minimized.

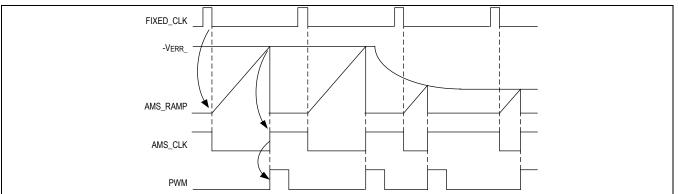


Figure 2. AMS Operation

#### **Discontinuous Current Mode (DCM) Operation**

The discontinuous current mode (DCM) operation can be enabled to improve the light load efficiency. The device has a DCM current detection comparator to monitor the inductor valley current while operating in the continuous current mode (CCM). At light load, if the inductor valley current is below the DCM comparator threshold for 48 consecutive cycles, the device transitions seamlessly to the DCM. Once in the DCM, the switching frequency decreases as the load decreases. The MAX16731 transitions back to the CCM operation as soon as the inductor valley current is higher than 0.6A.

#### **Internal Linear Regulator**

The MAX16731 contains an internal 1.8V linear regulator (LDO). The 1.8V LDO output voltage on V<sub>CC</sub> is derived from V<sub>DDH</sub> pin. It provides the supply voltage for the MOSFET gate drives. A decoupling capacitor of at least 4.7µF must be connected between the V<sub>CC</sub> and PGND. The AVDD pin of the MAX16731 also requires a 1.8V supply to power the device's internal analog circuitry. A 2.2 $\Omega$  to 4.7 $\Omega$  resistor must be connected between the AVDD and V<sub>CC</sub>. A 1µF or greater decoupling capacitor must be used between the AVDD and AGND.

#### Startup and Shutdown

The startup and shutdown timings are shown in *Figure 3*. When the AVDD pin voltage is above its rising UVLO threshold, the device goes through an initialization procedure. The configuration settings on the PGM\_pins are read. Once initialization is complete, the device detects  $V_{DDH}$  UVLO and EN status. When both are above their rising thresholds, the soft-start begins and switching is enabled. The output voltage of the enabled output starts to ramp up. The soft-start ramp time is 3ms. If there are no faults, the open drain PGOOD pin is released from being held low after the soft-start ramp is complete. The device supports smooth startup with output pre-biased.

During operation, if either the V<sub>DDH</sub> UVLO or EN falls below their thresholds, switching is stopped immediately. The output voltage is discharged by the load current.

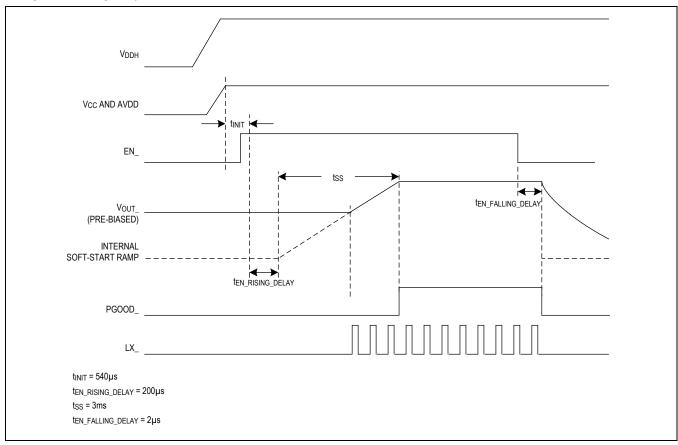


Figure 3. Startup and Shutdown Timing

#### Fault Handling

#### Input Undervoltage and Overvoltage Lockout (VDDH UVLO, VDDH OVLO)

The MAX16731 internally monitors the V<sub>DDH</sub> voltage level. When the input supply voltage is below the UVLO threshold or above the OVLO threshold, the device stops switching and drives the PGOOD pin low. The device restarts after 20ms if the UVLO or OVLO status is cleared. See the <u>Startup and Shutdown</u> for startup sequence.

#### **Output Overvoltage Protection (OVP)**

The feedback voltage of  $V_{SNSP} - V_{SNSN}$  is monitored for output overvoltage once the soft-start ramp is complete. If the feedback voltage is above the OVP threshold beyond the deglitch filtering delay, the device stops switching and drives PGOOD pin low. The device restarts after 20ms if the OVP status is cleared.

#### **Positive Overcurrent Protection (POCP)**

The device's peak current mode control architecture provides inherent current limiting and short circuit protection. The inductor current is continuously monitored while switching. The inductor peak current limits on a cycle-by-cycle basis. In each switching cycle, once the sensed inductor current exceeds the POCP threshold, the device turns off the high-side MOSFET and turns on the low-side MOSFET to allow the inductor current to be discharged by output voltage. An up-down counter is used to accumulate the number of consecutive POCP events each switching cycle. If the counter exceeds 512, the device stops switching and drives the PGOOD pin low. The POCP is a hiccup protection, and the device restarts after 20ms.

The MAX16731 offers three POCP thresholds (38A, 33A, and 28A), which can be selected by the PGM1 and PGM2 pins (see the *Pin-Strap Programmability*). Due to the POCP deglitch delay, for a specific application use case, the actual POCP threshold should be higher (see the *Selecting the Output Inductor*).

#### **Negative Overcurrent Protection (NOCP)**

The device also has negative overcurrent protection against inductor valley current. The NOCP threshold is -84% of the POCP threshold. In each switching cycle, once the sensed inductor current exceeds the NOCP threshold, the device turns off the low-side MOSFET and turns on the high-side MOSFET for a fixed 180ns time to allow the inductor current to be charged by input voltage. Same as POCP, an up-down counter is used to accumulate the number of consecutive NOCP events. If the counter exceeds 1024, the device stops switching and drives the PGOOD pin low. The NOCP is a hiccup protection, and the device restarts after 20ms.

#### **Overtemperature Protection (OTP)**

The overtemperature protection threshold is 155°C with 20°C hysteresis. If the junction temperature reaches OTP threshold during operation, the device stops switching and drives the PGOOD pin low. The device restarts after 20ms if the OTP status is cleared.

#### **Pin-Strap Programmability**

The MAX16731 has three program pins (PGM0, PGM1, and PGM2) to set some of the key configurations of the device. The PGM\_ values are read during startup initialization. The PGM0 has 32 detection levels. A pin-strap resistor is connected from PGM0 pin to AGND to select one of the 32 PGM0 codes. See <u>Table 1</u> for the PGM0 switching frequencies and scenario selections. The PGM0 is used to select the switching frequency and a pre-defined scenario, which is defined in <u>Table 3</u>. The PGM1 and PGM2 each has three levels. The PGM1 or PGM2 can be connected to AVDD or AGND (PGM0) or left OPEN to select the POCP level and DCM operation mode of the device as shown in <u>Table 2</u>.

### Table 1. PGM0 Switching Frequency and Scenario Selections

PGM0 CODES	R <sub>PGM0</sub> (Ω)	SWITCHING FREQUENCY (kHz)	SCENARIO #
0	95.3	500	A
1	200		В
2	309		С
3	422		D
4	536		E
5	649		F
6	768	600	A
7	909		В

8	1050		С
9	1210		D
10	1400		E
11	1620		F
12	1870	750	A
13	2150		В
14	2490		С
15	2870		D
16	3740		E
17	8060		F
18	12400	1000	А
19	16900		В
20	21500		С
21	26100		D
22	30900		E
23	36500		F
24	42200	1200	А
25	48700		В
26	56200		С
27	64900		D
28	75000		E
29	86600		F
30	100000	1500	А
31	115000		В

## Table 2. PGM1 and PGM2 Settings

PGM1&2	PGM1	PGM2	DCM	POCP (A)
CODES	CONNECTION	CONNECTION		
0		OPEN	Disable	38
1	OPEN	AGND	Enable	30
2		AVDD	Disable	28
3		OPEN	Enable	
4	AGND or PGM0	AGND	Disable	38
5		AVDD	Enable	
6		OPEN	Disable	00
7	AVDD	AGND	Enable	28
8		AVDD	Disable	33

The MAX16731 has six predefined scenarios as summarized in <u>Table 3</u>, which can be selected by a pin-strap resistor connected from PGM1 pin to AGND. See the <u>Voltage Loop Gain</u> for information to select the voltage loop gain resistance ( $R_{VGA}$ ) for optimized control loop performance.

## Table 3. Predefined Scenarios

SCENARIO #	R <sub>VGA</sub> (kΩ)
А	15.7
В	22.7
С	31.3
D	44.8
E	52.9
F	62.3

## **Reference Design Procedure**

#### **Output Voltage Sensing**

The MAX16731 has an internal 0.5V reference voltage. When the desired output voltage is higher than 0.5V, it is required to use a resistor divider  $R_{FB1}$  and  $R_{FB2}$  to sense the output voltage (see the <u>Typical Application Circuit</u>). It is recommended the value of  $R_{FB2}$  does not exceed 5k $\Omega$ . The resistor divider ratio is given by the following equation:

$$V_{OUT} = V_{REF} \left( 1 + \frac{R_{FB1}}{R_{FB2}} \right)$$

where:

V<sub>OUT</sub> = Output voltage

V<sub>REF</sub> = 0.5V fixed reference voltage

R<sub>FB1</sub> = Top divider resistor

RFB2 = Bottom divider resistor

#### Selecting the Switching Frequency

The MAX16731 offers a wide range of selectable switching frequencies from 500kHz to 1.5MHz. The selection of switching frequency can be optimized for different applications. Higher switching frequencies are recommended for the applications prioritizing solution size so that the value and size of the output LC filter can be reduced. Lower switching frequencies are recommended for the applications prioritizing efficiency and thermal dissipation, due to reduced switching losses. It is required that the frequency be selected so that the minimum controllable on-time and minimum controllable off-time are not violated. The maximum recommended switching frequency is calculated by the following equation:

$$f_{SWMAX} = MIN \left\{ \frac{V_{OUT}}{T_{ONMIN} \times V_{DDHMAX}}, \frac{V_{DDHMIN} - V_{OUT}}{T_{OFFMIN} \times V_{DDHMIN}} \right\}$$

where:

f<sub>SWMAX</sub> = Maximum selectable switching frequency

V<sub>DDHMAX</sub> = Maximum input voltage

V<sub>DDHMIN</sub> = Minimum input voltage

TONMIN = Minimum controllable on-time

T<sub>OFFMIN</sub> = Minimum controllable off-time

Due to system noise injection, even at steady-state operation, typically the LX rising and falling edges would have some random jittering noise. The selection of the switching frequency  $f_{SW}$  should consider the jittering and be lower than  $f_{SWMAX}$ . To improve the LX jittering, use smaller inductor values and lower voltage loop gain to minimize the noise sensitivity.

#### Selecting the Output Inductor

The output inductor has an important influence on the overall size, cost, and efficiency of the voltage regulator. Since the inductor is typically one of the larger components in the system, a minimum inductor value is particularly important in spaceconstrained applications. Smaller inductor values also permit faster transient response, reducing the amount of output capacitance needed to maintain transient tolerance. Typically, the output inductor is selected so that the inductor current ripple is 20% to 40% of the maximum load current for optimized performance. To improve current loop noise immunity, it is recommended that the inductor current ripple is at least 5A. The inductor value is calculated by the following equation:

$$L = \frac{V_{OUT}(V_{DDH} - V_{OUT})}{V_{DDH} \times I_{RIPPLE} \times f_{SW}}$$

where:

 $V_{DDH} = Input voltage$ 

IRIPPLE = Inductor current ripple peak-to-peak value

The inductor should also be selected so that maximum load current delivery can be guaranteed by the selected POCP threshold. The MAX16731 offers three POCP thresholds (38A, 33A, and 28A), which can be selected by PGM1 and PGM2

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pins (see the <u>Pin-Strap Programmability</u>). Due to deglitch delay from the POCP comparator tripping to high-side MOSFET turning off, for a specific application use case, the adjusted POCP threshold should consider the inductor value, input voltage and output voltage, which are calculated by the following equation:

$$POCP_{ADJUST} = POCP + \frac{(V_{DDH} - V_{OUT}) \times t_{POCP}}{L}$$

where:

POCP<sub>ADJUST</sub> = Adjusted POCP threshold

POCP = POCP level specified in the EC table

t<sub>POCP</sub> = POCP deglitch delay (51ns typical)

Verify that the peak inductor current in normal operation does not exceed the minimum adjusted POCP threshold:

$$I_{OUTMAX} + \frac{I_{RIPPLE}}{2} < POCP_{ADJUST(MIN)}$$

where:

IOUTMAX = Maximum load current

POCPADJUST(MIN) = Minimum adjusted POCP threshold, calculated with minimum value of the POCP threshold

Table 4 shows some suitable inductor part numbers verified on the MAX16731 evaluation kit to offer optimal performance.

#### Table 4. Recommended Inductors

COMPANY	VALUE (nH)	I <sub>SAT</sub> (A)	R <sub>DC</sub> (mΩ)	FOOTPRINT (mm)	HEIGHT (mm)	PART NUMBER
Eaton	180	70	0.17	10.8 × 8.0	8.0	FP1008R5-R180-R
Eaton	220	58	0.17	10.8 × 8.0	8.0	FP1008R5-R220-R
Eaton	270	44	0.17	10.8 × 8.0	8.0	FP1008R5-R270-R
Wurth	330	62.5	0.165	14.0 × 13.0	9.0	744309033
Wurth	470	40.5	0.165	14.0 × 13.0	9.0	744309047

#### Selecting the Output Capacitor

One major factor in determining the total required output capacitance is the output voltage ripple. To meet the output voltage ripple requirement, the minimum output capacitance should satisfy the following equation:

$$C_{OUT} = \frac{I_{RIPPLE}}{8 \times f_{SW} \times (V_{OUTRIPPLE} - ESR \times I_{RIPPLE})}$$

where:

VOUTRIPPLE = Maximum allowed output voltage ripple

#### ESR = ESR of output capacitors

The other important factors in determining the total required output capacitance are the maximum allowable output voltage overshoot and undershoot during load transients. For a given loading or unloading current step, the minimum required output capacitance should also satisfy the following equation:

$$C_{OUT} \ge MAX \left\{ \frac{\left(\Delta I + \frac{I_{RIPPLE}}{2}\right)^2 \times L}{2 \times \Delta V_{OUT} \times (V_{DDH} - V_{OUT})}, \frac{\left(\Delta I + \frac{I_{RIPPLE}}{2}\right)^2 \times L}{2 \times \Delta V_{OUT} \times V_{OUT}} \right\}$$

where:

C<sub>OUT</sub> = Output capacitance

 $\triangle I$  = Loading or unloading current step

 $\triangle V_{OUT}$  = Maximum allowed output voltage undershoot or overshoot

#### Selecting the Input Capacitor

The selection of input capacitance is determined by the requirement of input voltage ripple. The minimum required input capacitance is estimated by the following equation:

$$C_{IN} \ge \frac{I_{OUT(MAX)} \times V_{OUT}}{f_{SW} \times V_{DDH} \times V_{INPP}}$$

where:

I<sub>OUT(MAX)</sub> = Maximum output current

V<sub>OUT</sub> = Output voltage

f<sub>SW</sub> = Switching frequency

VINPP = Peak-to-peak input voltage ripple

Besides, the minimum required input capacitance, also place 0.1µF and 1µF high-frequency decoupling capacitors next to the V<sub>DDH</sub> pin to suppress the high-frequency switching noises.

#### Voltage Loop Gain

For stability purpose, the voltage loop bandwidth (BW) must be lower than 1/5 of the switching frequency. Consider the case of using the MLCC output capacitors with nearly ideal impedance characteristics in the frequency range of interest with negligible ESR and ESL. The voltage loop BW is estimated by the following equation:

$$BW = \frac{\frac{R_{FB2}}{R_{FB2} + R_{FB1}} \times \frac{R_{VGA}}{10k\Omega}}{2\pi \times 4m\Omega \times C_{OUT}}$$

where:

R<sub>VGA</sub> = The voltage loop gain resistance, which is set by the scenario selected (see <u>Table 3</u>).

### **Typical Reference Designs**

See the <u>Typical Application Circuit</u> or examples of reference schematics. Reference design examples for some common output voltages are shown in <u>Table 5</u>.

V <sub>OUT</sub> (V)	I <sub>OUT</sub> (A)	f <sub>SW</sub> (kHz)	R <sub>FB1</sub> (kΩ)	R <sub>FB2</sub> (kΩ)	PGM0 (Ω)	PGM1	PGM2	L (nH)	C <sub>IN</sub>	C <sub>OUT</sub>
0.8	30	500	1.82	3.01	200	OPEN	OPEN	220	4 × 22µF +1µF +0.1µF	8 × 100µF
0.9	30	500	2.40	3.01	200	OPEN	OPEN	220	4 × 22µF +1µF +0.1Mf	8 × 100µF
1.0	30	500	3.01	3.01	200	OPEN	OPEN	220	4 × 22µF +1µF +0.1µF	8 × 100µF
1.2	30	600	4.22	3.01	1050	OPEN	OPEN	220	4 × 22µF +1µF +0.1µF	8 × 100µF
1.8	25	750	7.87	3.01	2490	OPEN	OPEN	220	4 × 22µF +1µF +0.1µF	6 × 100µF
3.3	20	750	16.9	3.01	2870	AVDD	AVDD	470	4 × 22µF +1µF +0.1µF	6 × 100µF
5.0	15	1000	22.6	2.49	26100	OPEN	AVDD	470	4 × 22µF +1µF +0.1µF	4 × 100µF

### Table 5. Reference Design Examples

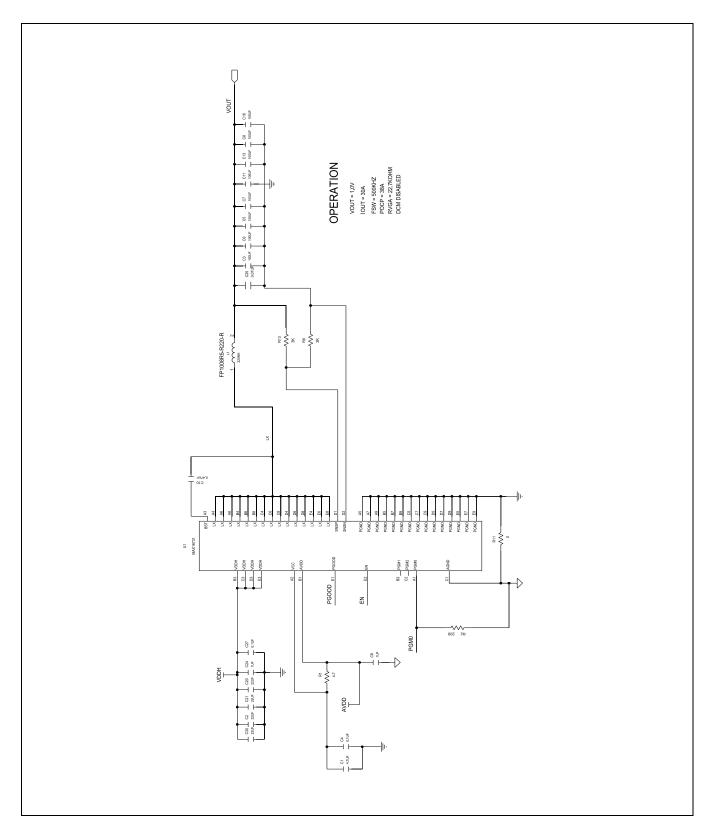
## **PCB Layout Guidelines**

- For electrical and thermal reasons, the second layer from the top and bottom of the PCB should be reserved for power ground (PGND) planes.
- The input decoupling capacitor should be located closest to the IC and no more than 40mils from the V<sub>DDH</sub> pin.
- The V<sub>CC</sub> decoupling capacitors should be connected to PGND and placed as close as possible to the V<sub>CC</sub> pin.
- An analog ground copper polygon or island should be used to connect all analog control-signal grounds. This "quiet" analog ground copper polygon or island should be connected to the PGND through a single connection close to the AGND pin. The analog ground can be used as a shield and ground reference for the control signals.
- The AVDD decoupling capacitors should be connected to AGND and placed as close as possible to the AVDD pin.
- The boost capacitors should be placed as close as possible to the LX and BST pins, on the same side of the PCB with the IC.

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- The feedback resistor-divider and optional external compensation network should be placed close to the IC to minimize the noise injection.
- Output voltage should be sensed with differential remote sense lines routed directly from an output capacitor from the load point, shielded by the ground plane, and must be kept away from the switching node and the inductor.
- Multiple vias are recommended for all paths that carry high currents and for heat dissipation.
- The input capacitors and output inductors should be placed near the IC and the traces to the components should be kept as short and wide as possible to minimize the parasitic inductance and resistance.

# **Typical Application Circuit**



# **Ordering Information**

PART NUMBER	TEMP RANGE	PIN-PACKAGE
MAX16731AWX+	-40°C to +125°C	45-Bump WLP
MAX16731AWX+T	-40°C to +125°C	45-Bump WLP

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION		
0	12/21	Initial release		



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